

FOUNDED: 1980

NASDAQ SYMBOL: LRCX

2009 REVENUE: \$1.2 Billion

EMPLOYEES: ~ 3,000

CORPORATE OVERVIEW:

Lam Research Corporation is a leading supplier of wafer fabrication equipment and services to the worldwide semiconductor industry, where we have been advancing semiconductor manufacturing for 30 years. As a technology and market share leader in plasma etch and single-wafer clean, we are dedicated to the success of our customers by being the world-class provider of innovative productivity solutions. With our broad product portfolio and expert customer support, we leverage our combined expertise to address some of today's most advanced semiconductor processing challenges.

With each new technology node, additional requirements and challenges drive the need for advanced manufacturing solutions. We strive to consistently deliver these advanced capabilities with cost-effective production performance. Lam's leading etch products address a broad range of applications, from conductor and dielectric etch to emerging micro-electromechanical systems (MEMS), deep silicon, and three-dimensional integrated circuit (3-D IC) applications. Our wafer cleaning and surface preparation solutions incorporate proprietary single-wafer spin, linear, and plasma-based clean and strip technologies, allowing our customers to implement customized yield-enhancing solutions.

Lam's Customer Support Business Group provides products and services to maximize installed equipment performance and operational efficiency. A full suite of offerings – including customer service, spares, upgrades, technical training, and legacy products – deliver value throughout the complete equipment life cycle, from system installation, production ramp, and new technology upgrades through end-of-life asset management.

MILESTONES:

- 1980 Founded by David K. Lam
- 1981 Introduced first product, the AutoEtch 480, for poly-silicon etch
- 1984 Achieved IPO and listing on NASDAQ
- 1985 Established a global presence with offices in Asia and Europe
Introduced first oxide etch system, the AutoEtch 590
- 1987 Introduced Rainbow[®] 4400 Etch Series (successor to AutoEtch) for poly-silicon etch
- 1990 Established presence in China
- 1992 Introduced first Transformer Coupled Plasma[™] source technology based products, the TCP[®] 9400 for silicon etch and the TCP[®] 9600 for metal etch
- 1993 Opened process development center in Japan
Introduced Alliance[®] cluster tool platform
- 1994 Opened R&D center at Fremont, California headquarters
- 1995 Achieved 0.25 micron process capabilities in all served markets
Introduced first product incorporating Dual Frequency Confined[™] technology, 4520XL[™] dielectric etch system
- 1996 Introduced improved DFC technology, 4520XL^E[™] dielectric etch system
- 1997 Acquired OnTrak Systems, Inc.
Appointed James W. Bagley as Chief Executive Officer
Appointed Stephen G. Newberry as Chief Operating Officer
- 1998 Appointed James W. Bagley as Chairman of the Board

- MILESTONES:**
- 1999 Introduced next-generation Exelan® dielectric etch system employing DFC plasma source technology
 - 2000 Launched 2300® etch series, offering 200 mm and 300 mm capability
 - 2001 Achieved ISO 9001:2000 Quality System registration
Introduced the TCP® 9600DFM™ metal etch system for sub-150 nm processes
 - 2002 Launched 2300® Versys® Star™ silicon etch system for sub-90 nm applications
Released MyLam.com®, an external website for customers
 - 2003 Achieved ISO 14001 environmental management system registration
 - 2004 Launched 2300® Versys® Kiyō® silicon etch system extending Versys technology to 65 nm and beyond
 - 2005 Lam Research celebrates its 25th anniversary
Appointed Steve G. Newberry as President and Chief Executive Officer
 - 2006 Acquisition of Bullen Semiconductor (now Silfex™, Inc.)
 - 2007 Shipped first 300 mm 2300® Syndion® system for 3-D IC through-silicon via etch
Launched 2300® Coronus® plasma-based bevel clean system
 - 2008 Acquisition of SEZ AG (now Lam Research AG)
Launched the 2300® Kiyō® C Series conductor etch system
 - 2010 Lam Research 30th anniversary

- PRODUCT OFFERINGS:**
- Conductor Etch: 2300® Kiyō® product family, 2300® Versys® Metal product family
 - Dielectric Etch: 2300® Flex™ product family
 - MEMS & Deep Silicon Etch: TCP® 9400DSiE™
 - 3-D IC Etch: 2300® Syndion®
 - Single-Wafer Spin Clean: DV-Prime™, Da Vinci®, SP323
 - Single-Wafer Linear Clean: 2300® Serene®
 - Single-Wafer Plasma-Based Bevel Clean: 2300® Coronus®
 - Software: 2300® Series Software Applications

CORPORATE HEADQUARTERS:

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Fremont, CA 94538
1 (510) 572-0200
1 (800) 526-7678

GLOBAL OPERATIONS:

Lam Research maintains local service, sales, and support offices in North America, Europe, and Asia in order to meet the needs of its global customer base.

WEBSITE:

www.lamresearch.com

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